Journal Evaluation Processing

International Journal of Engineering & Technology



Date: 1.10.2018

ICICAM-071

Dear(s), Nafisa Firmania, Putu Sudira, Asnul Dahar Minghat,

We received your article. Thank you very much for your submission in International Journal of Engineering and Technology (IJET UAE). We interested with your article entitled "Literature Review: Authentic Assessment In Vocational High Schools" and we have pleasure to inform you that your article was under evaluation processes. Please wait for these processes until finished.

With Kind Regards, Yours Sincerely,



International Journal of Engineering & Technology

http://www.sciencepubco.com/index.php/IJET

Science Publishing Corporation, P.O. Box: 487447, Dubai, UAE

Acceptance Letter

International Journal of Engineering & Technology



Date: 15.10.2018

ICICAM-071

Dear(s), Nafisa Firmania, Putu Sudira, Asnul Dahar Minghat,

We are happy to inform you that after positive referee reports, your paper "Literature Review: Authentic Assessment In Vocational High Schools" has been accepted for publication in "International Journal of Engineering & Technology" as special issue entitled "ICICAM".

With Kind Regards, Yours Sincerely,



International Journal of Engineering & Technology

http://www.sciencepubco.com/index.php/IJET

Science Publishing Corporation, P.O. Box: 487447, Dubai, UAE





Receipt Date: 18th October 2018 Receipt. No.: 071/IJET/ICICAM/2018

Received from: Zairi Ismael Rizman

To:

Nafisa Firmania Vocational and Technology Education Postgraduate Program Yogyakarta State University Indonesia

Dear Nafisa Firmania,

Thanks for your submission to International Journal of Engineering & Technology (IJET) (SCOPUS indexed).

No.	Title		Qty	Unit Price	Total
1.	Literature Review: Authentic Assessment In	n	1	RM900	RM900
	Vocational High Schools				

Total Amount Paid: RM900.00

Thank you very much for your kind co-operation.

With Kind Regards,

Yours Sincerely,

gairi

Zairi Ismael Rizman Guest Editor International Journal of Engineering & Technology E-mail: zairi576@tganu.uitm.edu.my

Science Publishing Corporation, P.O. Box: 487447, Dubai, UAE